



## PAPER

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# Room-temperature spin-valve devices based on $\text{Fe}_3\text{GaTe}_2/\text{MoS}_2/\text{Fe}_3\text{GaTe}_2$ 2D van der Waals heterojunctions†

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The spin-valve effect has been the focus of spintronics over the last decades due to its potential for application in many spintronic devices. Two-dimensional (2D) van der Waals (vdW) materials are highly efficient to build spin-valve heterojunctions. However, the Curie temperatures ( $T_C$ ) of the vdW ferromagnetic (FM) 2D crystals are mostly below room temperature ( $\sim 30$ – $220$  K). It is very challenging to develop room-temperature, FM 2D crystal-based spin-valve devices. Here, we report room-temperature, FM 2D-crystal-based all-2D vdW  $\text{Fe}_3\text{GaTe}_2/\text{MoS}_2/\text{Fe}_3\text{GaTe}_2$  spin-valve devices. The magnetoresistance (MR) of the device was up to 15.89% at 2.3 K and 11.97% at 10 K, which are 4–30 times the MR of the spin valves of  $\text{Fe}_3\text{GaTe}_2/\text{MoS}_2/\text{Fe}_3\text{GaTe}_2$  and conventional  $\text{NiFe}/\text{MoS}_2/\text{NiFe}$ . The typical spin valve effect showed strong dependence on the  $\text{MoS}_2$  spacer thickness in the vdW heterojunction. Importantly, the spin valve effect (0.31%) robustly existed even at 300 K with low working currents down to 10 nA ( $0.13 \text{ A cm}^{-2}$ ). This work provides a general vdW platform to develop room-temperature, 2D FM-crystal-based 2D spin-valve devices.

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## 1. Introduction

The spin-valve effect has been the focus of spintronics over the last decades due to its application in magnetoresistance sensors,<sup>1–3</sup> magnetic random-access memory<sup>4,5</sup> and read heads for high-density magnetic recording.<sup>6,7</sup> Typically, spin-valve devices consist of two ferromagnetic (FM) electrodes separated by a nonmagnetic spacer layer. Traditional ferromagnets, such as Fe,<sup>8</sup> NiFe,<sup>9</sup> Co<sup>10</sup> or CoFeB,<sup>11</sup> have been extensively investigated as FM electrodes in spin-valve devices. To obtain a well-defined interface regardless of lattice mismatch, two-dimensional (2D) van der Waals (vdW) materials are considered highly suitable to build spin-valve heterojunctions due to their perfectly flat surface without any dangling bonds.<sup>12–17</sup>

Over the past few years, 2D vdW materials have been theoretically and experimentally demonstrated as non-magnetic spacer layers based on the tunneling or spin-valve effect because they yield large tunneling magnetoresistance (TMR) or magnetoresistance (MR). Different types of spacer layers contribute to different physical mechanisms in the devices. In BN-based spin-valve devices, high TMR was obtained when BN served as a tunneling barrier.<sup>18</sup> In  $\text{Fe}_3\text{GaTe}_2/\text{graphite}/\text{Fe}_3\text{GaTe}_2$  heterostructures, an antisymmetric three-state MR effect was observed, revealing spin-momentum locking caused by the SOC-induced Rashba-split 2D electron gas at the  $\text{Fe}_3\text{GaTe}_2/\text{graphite}$  interface.<sup>19</sup> Moreover, transition-metal dichalcogenide (TMDC) semiconductors are another kind of promising candidates for non-magnetic spacer layers due to their fascinating physical properties.<sup>20,21</sup> Under the influence of different thicknesses or defects, the TMDC semiconductors play two different roles in the spin-valve heterojunctions as the conducting or tunneling layer. For example, the spacers in  $\text{NiFe}/\text{MoS}_2/\text{NiFe}$ ,<sup>22</sup>  $\text{NiFe}/\text{WSe}_2/\text{NiFe}$ <sup>23</sup> and  $\text{Fe}_3\text{GaTe}_2/\text{MoS}_2/\text{Fe}_3\text{GaTe}_2$ <sup>24</sup> act as conducting layers, while in the  $\text{Fe}_3\text{GaTe}_2/\text{WSe}_2/\text{Fe}_3\text{GaTe}_2$ <sup>25</sup> heterojunction,  $\text{WSe}_2$  acts as the tunneling layer. Despite these TMDC semiconductors, including  $\text{MoS}_2$ , as the spacer layers have been reported, room-temperature all-2D vdW  $\text{MoS}_2$ -based spin valves are still rare, making it critical to realize room-temperature FM in 2D vdW materials for the practical application of 2D spin-valve devices in spintronics.

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Theoretically, long-range ferromagnetism hardly exists in 2D materials because of thermal fluctuations,<sup>26</sup> which, meanwhile, can be stabilized by the excitation gap induced by magnetic anisotropy.<sup>27</sup> To date, progress has been made in the research of intrinsic 2D FM crystals, such as  $\text{CrI}_3$ ,<sup>28</sup>  $\text{Cr}_2\text{Ge}_2\text{Te}_6$ <sup>27</sup> and  $\text{Fe}_3\text{GaTe}_2$ ,<sup>29</sup> but the Curie temperatures ( $T_C$ ) of these FM 2D crystals are mostly below the room temperature ( $\sim 30$ – $220$  K), which can hinder their practical room-temperature application in next-generation spin-valve spintronic devices. Recently, the emergence of  $\text{Fe}_3\text{GaTe}_2$  with an above-room temperature  $T_C$  and robust large room-temperature-perpendicular magnetic anisotropy (PMA)<sup>30</sup> realizes the practical room-temperature application of 2D vdW FM crystal-based spin-valve devices in spintronics.

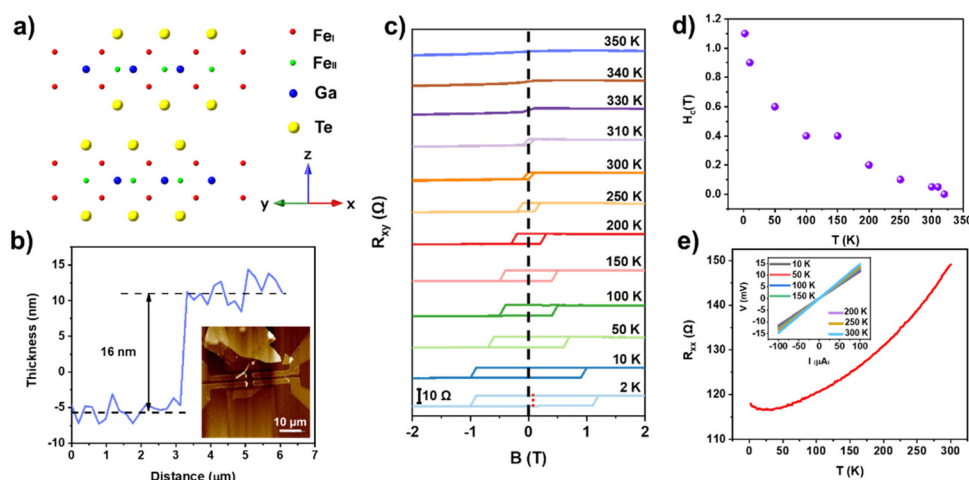
In this work, we report room-temperature all-2D vdW  $\text{Fe}_3\text{GaTe}_2/\text{MoS}_2/\text{Fe}_3\text{GaTe}_2$  spin-valve devices with  $\text{Fe}_3\text{GaTe}_2$  as the top and bottom FM electrodes and few-layer  $\text{MoS}_2$  as the spacer. A typical spin-valve effect was observed in the heterojunction with the formation of Ohmic contacts at the  $\text{Fe}_3\text{GaTe}_2/\text{MoS}_2$  interfaces, according to linear current-voltage ( $I$ - $V$ ) curves. The MR of the all-2D vdW spin-valve device was up to 15.89% at 2.3 K and continued to robustly exist (0.31%) at 300 K with low working currents down to 10 nA ( $0.13 \text{ A cm}^{-2}$ ).

## 2. Results and discussion

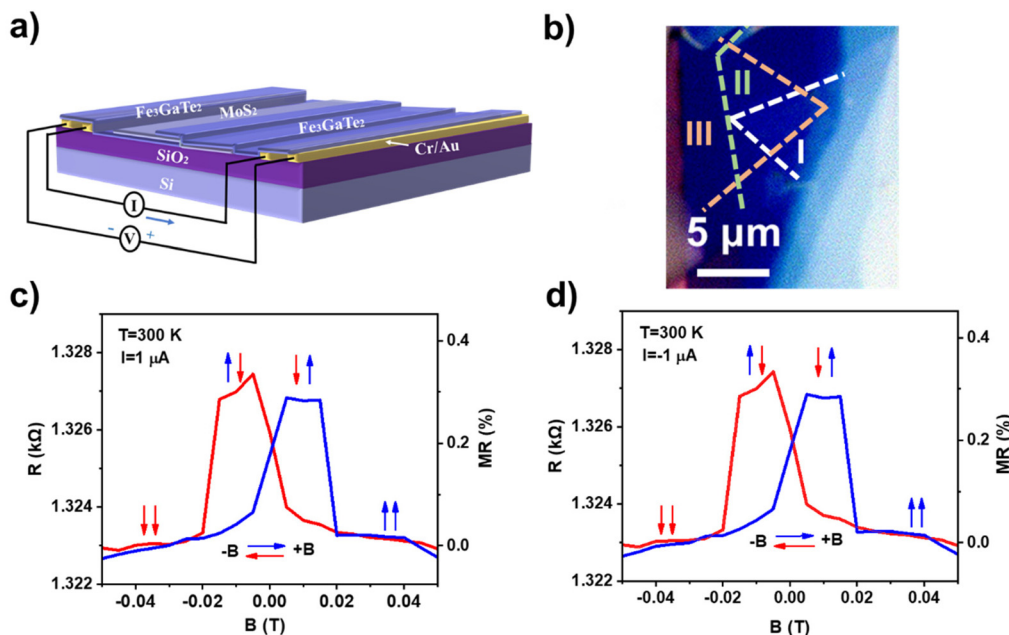
The crystal structure of  $\text{Fe}_3\text{GaTe}_2$  is schematically illustrated in Fig. 1a, which shows a hexagonal arrangement belonging to the  $P6_3/mmc$  space group ( $a = b = 3.9860 \text{ \AA}$ ,  $c = 16.2290 \text{ \AA}$ ,  $\alpha = \beta = 90^\circ$ ,  $\gamma = 120^\circ$ ). In 2D  $\text{Fe}_3\text{GaTe}_2$ , the  $\text{Fe}_3\text{Ga}$  heterometallic slab was in the middle, with the Te atoms on the top and bottom sides, forming a typical sandwiched structure. The adjacent

layers were connected by weak vdW forces with an interlayer thickness of  $0.78 \text{ nm}$ . The magneto-transport properties were revealed by the Anomalous Hall Effect (AHE) in a Hall device. As shown in Fig. 1b, the thickness of the 2D  $\text{Fe}_3\text{GaTe}_2$  crystal in the Hall device was  $16 \text{ nm}$ . Fig. 1e shows the temperature-dependent longitudinal resistance  $R_{xx}$ ; as the temperature was decreased from  $300 \text{ K}$  to  $2 \text{ K}$ , the  $R_{xx}$  declined monotonously, implying the metallic characteristics of  $\text{Fe}_3\text{GaTe}_2$ . Meanwhile, the corresponding  $I$ - $V$  curves at different temperatures in the inset of Fig. 1e are linear, which verifies the Ohmic contact between the electrodes and  $\text{Fe}_3\text{GaTe}_2$ . Fig. 1c shows the Anomalous Hall resistance ( $R_{xy}$ ) of the device with an out-of-plane magnetic field at various temperatures. The large PMA was clearly indicated by the rectangular hysteresis loops, and the  $T_C$  was up to  $340 \text{ K}$ , which are similar to our previous report.<sup>17</sup> Notably, the hysteresis loop measured at  $2 \text{ K}$  was a little right-shifted ( $\sim 500 \text{ Oe}$ ), which may originate from the exchange bias effect. Since the Hall device was not encapsulated, the surface layer of  $\text{Fe}_3\text{GaTe}_2$  maybe oxidized before testing, forming an  $\text{O-Fe}_3\text{GaTe}_2/\text{Fe}_3\text{GaTe}_2$  interface (antiferromagnet/ferromagnet) and thus causing the exchange bias.<sup>31</sup> The coercivities ( $H_C$ ) extracted from the AHE results (Fig. 1d) were temperature-dependent, and they declined as the temperature increased as a result of intensifying thermal fluctuations. The above-mentioned room-temperature  $T_C$ , strong PMA and large  $H_C$  verify the good quality of the  $\text{Fe}_3\text{GaTe}_2$  crystal, making it an ideal metallic FM electrode material for room-temperature spin valves.

The fabricated spin-valve device consisted of two FM electrodes ( $\text{Fe}_3\text{GaTe}_2$ ) and a non-magnetic spacer layer ( $\text{MoS}_2$ ); the diagram of the structure is shown in Fig. 2a.  $\text{MoS}_2$  is a semiconductor with a tunable bandgap ( $1.8 \text{ eV}$  in the monolayer and  $1.2 \text{ eV}$  in the bulk<sup>32–34</sup>), whereas its vertical conductivity is relatively poor due to the weak interlayer interaction,<sup>35</sup> thus



**Fig. 1** The crystal structure and magneto-transport characterization of the vdW layered  $\text{Fe}_3\text{GaTe}_2$  single crystals. (a) The front view of the crystal structure of  $\text{Fe}_3\text{GaTe}_2$ . (b) The AFM height profile and topography (inset) of the  $\text{Fe}_3\text{GaTe}_2$  Hall device. (c) Hall resistance ( $R_{xy}$ ) at different temperatures from  $2 \text{ K}$  to  $350 \text{ K}$ . (d) The extracted coercivities as a function of temperature. (e) The temperature-dependence of longitudinal resistance ( $R_{xx}$ ). Inset:  $I$ - $V$  curves at different temperatures.



**Fig. 2** Spin-valve device characterization and magneto-transport properties. (a) The schematic of the Fe<sub>3</sub>GaTe<sub>2</sub>/MoS<sub>2</sub>/Fe<sub>3</sub>GaTe<sub>2</sub> heterojunction spin-valve device. (b) The optical image of the device; regions I, II and III represent the bottom Fe<sub>3</sub>GaTe<sub>2</sub>, MoS<sub>2</sub>, and top Fe<sub>3</sub>GaTe<sub>2</sub> layers, respectively. (c and d) Resistance and MR vs the perpendicular magnetic field at 300 K with a bias current of 1 μA and -1 μA. The arrows represent the magnetization alignment directions of Fe<sub>3</sub>GaTe<sub>2</sub>.

making it an appropriate spacer layer for spin-valve devices. To avoid damage and contamination of this layer during the deposition of the Cr/Au electrodes, we fabricated the metal electrodes first, and the following procedure was finished in an Ar-filled glove box. We applied a four-terminal setup to measure the magnetoresistance (MR) so that the contact resistance of the device was excluded. The magneto-transport measurements were carried out under a magnetic field directed perpendicular to the *ab* plane. To observe the spin-valve effect, the switching fields of the two FM electrodes should be different.<sup>36,37</sup> The switching fields are decided by the coercivity of Fe<sub>3</sub>GaTe<sub>2</sub>, which depends on the geometry and thickness of Fe<sub>3</sub>GaTe<sub>2</sub>.<sup>38</sup> Thus, we selected Fe<sub>3</sub>GaTe<sub>2</sub> with different geometry and thickness as the FM metal layers. The AFM image and the thickness profile of the device are shown in Fig. S1 in ESI,<sup>†</sup> indicating that the top and bottom Fe<sub>3</sub>GaTe<sub>2</sub> layers measured 16.8 nm and 9.5 nm, respectively, and the middle few-layer MoS<sub>2</sub> had a thickness of 4.5 nm. In addition, the Raman spectra of the top and bottom Fe<sub>3</sub>GaTe<sub>2</sub> layers, MoS<sub>2</sub> and the heterojunction are shown in Fig. S2 in ESI,<sup>†</sup> indicating the successful formation of the multilayer heterojunction. Moreover, the Raman signals of MoS<sub>2</sub> exhibited an in-plane vibration mode  $E_{2g}^1$  ( $\sim 383$  cm<sup>-1</sup>) and the out-of-plane  $A_{1g}$  mode ( $\sim 406$  cm<sup>-1</sup>); the difference between  $E_{2g}^1$  and  $A_{1g}$  was  $\sim 23$  cm<sup>-1</sup>, suggesting the presence of multilayer MoS<sub>2</sub>,<sup>39,40</sup> which is consistent with the AFM tests. It is worth mentioning that no shift or split of the  $E_{2g}^1$  and  $A_{1g}$  modes of MoS<sub>2</sub> was observed in the Raman spectra after the formation of the heterojunction, implying that no significant defects or strains

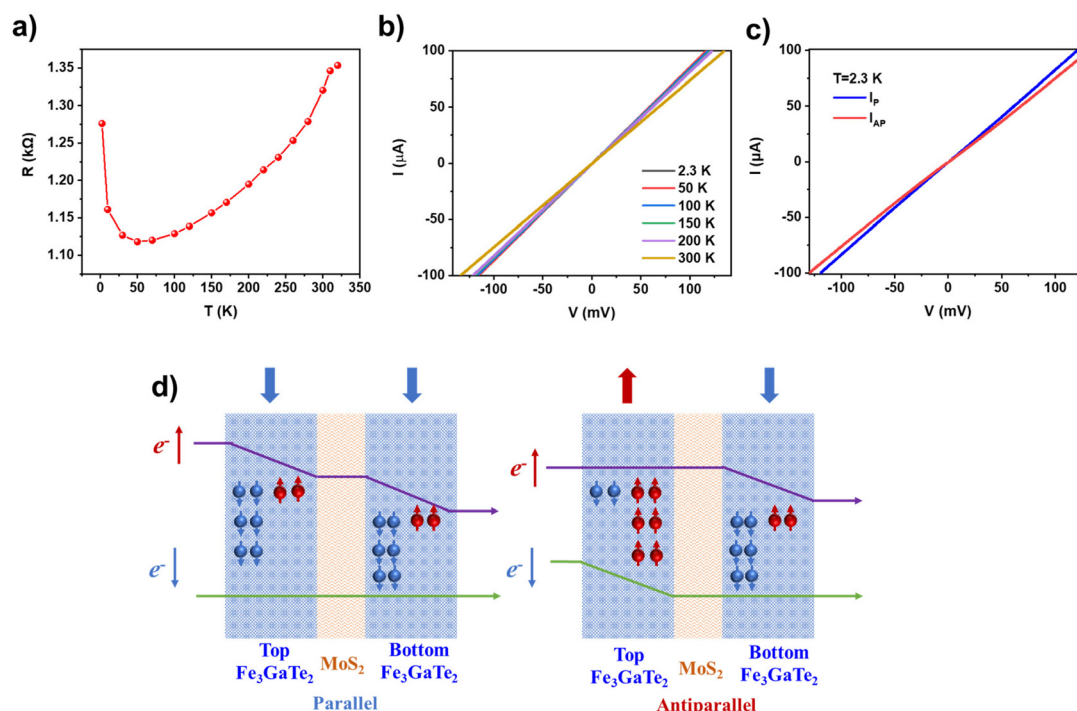
were induced during the fabrication of the device. The all-2D vdW structure ensured no damage or degradation occurred in the 2D nonmagnetic spacer layer, which can be inevitably caused during 3D FM electrode deposition in traditional spin valves.<sup>41</sup> Fig. 2c displays a typical MR curve with 1 μA bias current at 300 K. The perpendicular magnetic field was applied to sweep between -0.05 T and 0.05 T (blue square), and the resistance increased abruptly at  $B = 50$  Oe and continued until  $B = 200$  Oe. As the applied magnetic field became larger, the resistance exhibited a sudden decrease. When sweeping backwards (red square), a similar sudden increase followed by a decrease was observed. The two distinct values of resistance corresponded with the magnetization switching of the two Fe<sub>3</sub>GaTe<sub>2</sub> layers. To begin with, the magnetization direction of the two Fe<sub>3</sub>GaTe<sub>2</sub> layers was parallel, corresponding to low resistance. While reversing the magnetization, the magnetization vector of the Fe<sub>3</sub>GaTe<sub>2</sub> layer with small coercivity will turn over first, rendering the magnetization direction of the two Fe<sub>3</sub>GaTe<sub>2</sub> layers antiparallel. The optical image of the device is shown in Fig. 2b; regions I, II and III are circled by white, green and orange dashed lines, respectively, representing the bottom Fe<sub>3</sub>GaTe<sub>2</sub>, MoS<sub>2</sub>, and top Fe<sub>3</sub>GaTe<sub>2</sub> layers, respectively. According to Fig. 2b, the area of the heterojunction was estimated as 7.75 μm<sup>2</sup>, and thus, the resistance-area product (RA) was 10.25 kΩ μm<sup>2</sup> at 300 K. The MR ratio was obtained according to the equation  $MR = (R_{AP} - R_P)/R_P$ , where  $R_{AP}$  and  $R_P$  refer to the resistance of the antiparallel and parallel magnetic configurations of the two Fe<sub>3</sub>GaTe<sub>2</sub> layers, respectively. According to the equation, the MR ratio of the Fe<sub>3</sub>GaTe<sub>2</sub>/

MoS<sub>2</sub>/Fe<sub>3</sub>GaTe<sub>2</sub> heterojunction was determined as 0.31% at 300 K (Fig. 2c) and 15.89% at 2.3 K (see data and discussion on Fig. 4a below). The MR at 10 K (11.97%) was approximately 30 times and 16 times that of the conventional spin valves NiFe/MoS<sub>2</sub>/NiFe (0.4%) and NiFe/Au/MoS<sub>2</sub>/NiFe (0.73),<sup>22</sup> respectively, and 4 times that of the Fe<sub>3</sub>GeTe<sub>2</sub>/MoS<sub>2</sub>/Fe<sub>3</sub>GeTe<sub>2</sub> (3.1%)<sup>24</sup> spin valve. Moreover, when a reverse bias current was applied during MR measurement (Fig. 2d), the MR ratio showed little difference compared with that obtained from Fig. 2c, suggesting that the interface in the fabricated spin valve was symmetric.

The electrical characteristics were investigated next. Fig. 3a depicts the temperature-dependent resistance exhibiting an overall downward trend, indicating metallic behavior. The vertical heterojunction resistance was dominated by MoS<sub>2</sub>, which is a semiconductor, while the junction showed metallic behavior. This can be the result of the strong hybridization between the S atoms of MoS<sub>2</sub> and the Te/Ga/Fe atoms.<sup>42</sup> Notably, there was an increase as the temperature dipped below 50 K due to the Kondo effect. The linear current-voltage (*I*-*V*) curves at various temperatures in Fig. 3b suggest Ohmic contact between Fe<sub>3</sub>GaTe<sub>2</sub> and MoS<sub>2</sub>. Besides, they also imply that no tunnel barrier was formed in the heterojunction, and MoS<sub>2</sub> acted as a conducting layer that enables the two Fe<sub>3</sub>GaTe<sub>2</sub> electrodes to be flipped independently under a magnetic field, which is critical to spin transport between the two FM layers. Fig. 3c shows the *I*-*V* curves tested in the parallel (*I*<sub>P</sub>) and anti-

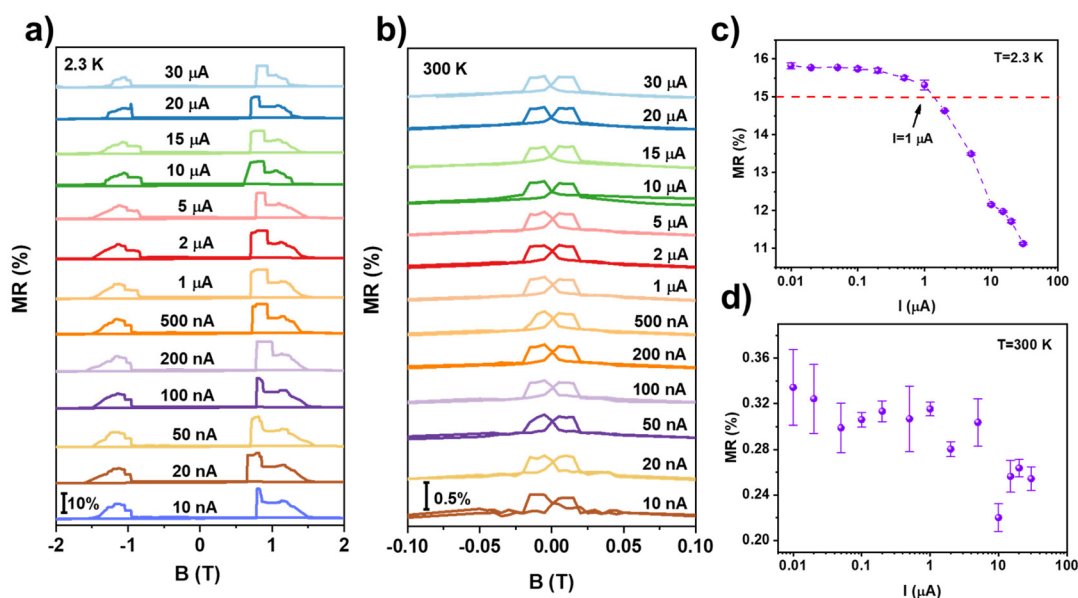
parallel (*I*<sub>AP</sub>) magnetization modes at 2.3 K, where low and high resistances were obtained, corresponding to the MR-B test.

To understand the physical mechanism of our spin-valve devices, the schematics of electron transport in the Fe<sub>3</sub>GaTe<sub>2</sub>/MoS<sub>2</sub>/Fe<sub>3</sub>GaTe<sub>2</sub> heterojunctions are shown in Fig. 3d, where the purple and green lines represent the transport channels for the spin-up and -down electrons, respectively, while blue and red arrows indicate the magnetization directions of the Fe<sub>3</sub>GaTe<sub>2</sub> electrodes. As the current flows through the heterojunction, it is proportional to the product of density of states (DOS) of the two Fe<sub>3</sub>GaTe<sub>2</sub> electrodes.<sup>43,44</sup> The junction resistances can be attributed to the difference in the DOS of the majority and minority spins, which is determined by the magnetization direction. To be specific, when the two Fe<sub>3</sub>GaTe<sub>2</sub> electrodes are magnetized downward (in the parallel magnetic configuration, left panel of Fig. 3d), the spin-up electrons of the two electrodes are intensely scattered due to their low DOS, contributing to high spin-up channel resistance, while the scattering of the spin-down electrons is less as they can pass through the junction, and the spin-down channel resistance is relatively low, thus leading to low junction resistance (*R*<sub>P</sub>). When the top and bottom Fe<sub>3</sub>GaTe<sub>2</sub> electrodes are magnetized upward and downward, respectively (in the antiparallel magnetic configuration, right of Fig. 3d), the spin-up and -down electrons are intensely scattered in the bottom and top Fe<sub>3</sub>GaTe<sub>2</sub> layers, respectively. Thus, the resistances of both the



**Fig. 3** The electrical and magneto-transport properties of the Fe<sub>3</sub>GaTe<sub>2</sub>/MoS<sub>2</sub>/Fe<sub>3</sub>GaTe<sub>2</sub> heterojunction spin-valve device. (a) Resistance vs. temperature of the spin-valve device. (b) *I*-*V* curves at different temperatures. (c) *I*-*V* curves measured at the parallel (*I*<sub>P</sub>) and antiparallel (*I*<sub>AP</sub>) magnetization configurations at 2.3 K. (d) The schematic of electron transport in the Fe<sub>3</sub>GaTe<sub>2</sub>/MoS<sub>2</sub>/Fe<sub>3</sub>GaTe<sub>2</sub> heterojunction when the two Fe<sub>3</sub>GaTe<sub>2</sub> electrodes are in the parallel and antiparallel configurations, respectively.





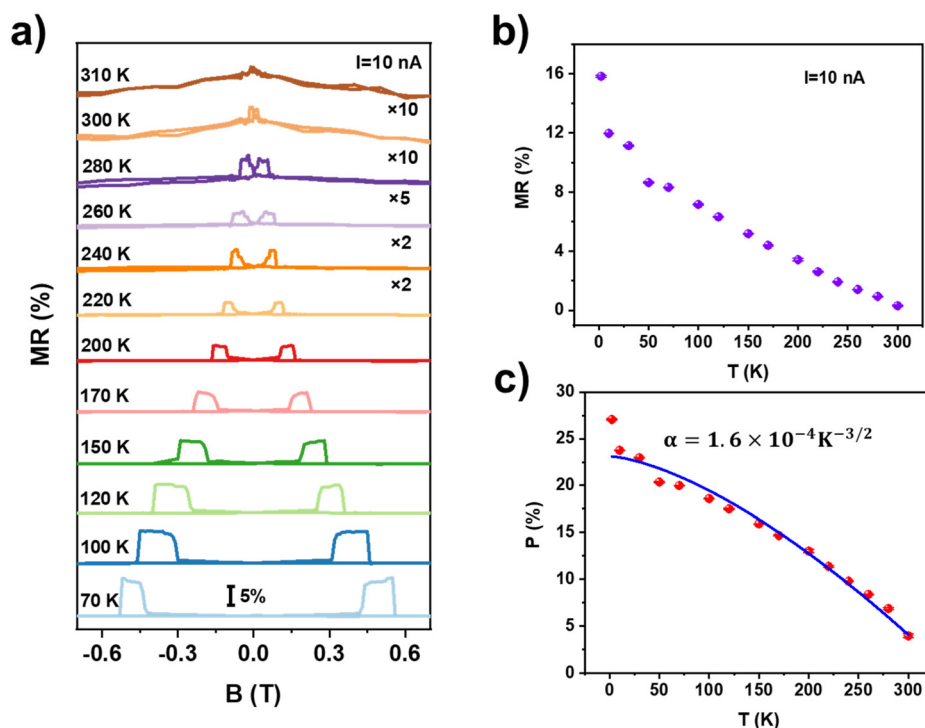
**Fig. 4** Bias-current-dependence of the spin-valve effect in the  $\text{Fe}_3\text{GaTe}_2/\text{MoS}_2/\text{Fe}_3\text{GaTe}_2$  device. MR curves measured at different bias currents from 10 nA to 30  $\mu\text{A}$  at (a) 2.3 K and (b) 300 K. The extracted MR ratios as a function of the bias current at (c) 2.3 K and (d) 300 K.

spin-up and spin-down channels are high, producing high junction resistance ( $R_{\text{AP}}$ ).

To investigate the influence of the performing current on the performance of the spin valve, MR measurements at various bias currents were carried out at 2.3 K and 300 K, respectively. As shown in Fig. 4a and b, the spin-valve effect was observed at bias currents ranging from 10 nA to 30  $\mu\text{A}$ , resulting in the maintenance of stable low working currents down to 10 nA ( $0.13 \text{ A cm}^{-2}$ ) at both 2.3 K and 300 K. The current intensity could have been lower, but the test was limited by our physical property measurement system. This indicates that the spin valve can work as a low-power-consumption device at room temperature and has great potential in room-temperature spintronics. Notably, the MR curves measured at 2.3 K (Fig. 4a) were not symmetrical, implying that the coercivities of  $\text{Fe}_3\text{GaTe}_2$  under negative and positive magnetic fields are different, which might be related to the pinning of magnetization induced by defects.<sup>45</sup> At higher temperatures, the pinning was weakened, as shown in Fig. 4b. Moreover, multiple jumps were observed (Fig. 4a), which is caused by the reversal of magnetization at different parts of the junction due to the slightly different values of the magnetic field.<sup>46</sup> Fig. 4c and d demonstrate the current-dependent MR values extracted from Fig. 4a and b, respectively. At 2.3 K, when the bias current was smaller than 1  $\mu\text{A}$ , the MR ratio was maintained at  $\sim 15.5\%$ , suggesting that the spin valve can work in a wide range of bias currents. As the applied bias current increased exponentially, the MR almost decreased linearly, which might be corresponding to high-energy electron scattering at the interface of  $\text{Fe}_3\text{GaTe}_2/\text{MoS}_2$ .<sup>47</sup> At 300 K, the MR ratio showed little dependence on the bias current, and we speculate that this is because the enhancement in thermal

fluctuation diminishes electron scattering.<sup>47</sup> To understand the influence of  $\text{MoS}_2$  thickness on the MR ratio of the spin valve, other devices with three different  $\text{MoS}_2$  thicknesses were fabricated, as shown in Fig. S4.† The three representative devices were tested at 2.3 K with 1  $\mu\text{A}$  bias current, and the MR showed a spacer layer thickness-dependent behavior. When the  $\text{MoS}_2$  layer thickness was 8 nm, the MR was 2.4%. With an increase in the thickness of  $\text{MoS}_2$  to 10 nm, the MR dropped to 0.77% and finally down to 0.53% when the  $\text{MoS}_2$  thickness was 17 nm. MR decreased monotonically as the thickness increased, which could be further optimized by adjusting the thickness of the spacer.

The temperature dependence of the spin valve was further studied by measuring the MR ratios at various temperatures up to 310 K. The MR ratios extracted from Fig. 5a are shown in Fig. 5b. The MR ratio monotonically decreased as the temperature increased and still retained its value at room temperature, corresponding to the  $T_{\text{C}}$  of  $\text{Fe}_3\text{GaTe}_2$ . MR is closely dependent on spin polarization, which can be described as  $\text{MR} = \frac{2P_1P_2}{1 - P_1P_2}$ , according to the Julliere model,<sup>48</sup> where  $P_1$  and  $P_2$  refer to the spin polarization values of the top and bottom FM layers. In our spin-valve device, the two FM layers were of the same material, so we set  $P_1 \approx P_2 = P$ . Based on this, the relationship between the calculated  $P$  and temperature is depicted in Fig. 5c; the  $P$  value decreased from 27% to 4% as the temperature was increased from 2.3 K to 300 K, which is higher than that observed in other  $\text{MoS}_2$ -based spin-valve devices. However, compared with heterojunctions that are based on the tunneling effect, such as  $\text{Fe}_3\text{GeTe}_2/\text{InSe}/\text{Fe}_3\text{GeTe}_2$ ,<sup>49</sup>  $\text{Fe}_3\text{GeTe}_2/\text{BN}/\text{Fe}_3\text{GeTe}_2$ ,<sup>18</sup> and  $\text{Fe}_3\text{GaTe}_2/\text{WSe}_2/\text{Fe}_3\text{GaTe}_2$ ,<sup>50</sup> this value is still relatively low due to the spin-polarization loss in  $\text{Fe}_3\text{GaTe}_2$  when the electrons cross through



**Fig. 5** Temperature-dependence of the spin-valve effect in the  $\text{Fe}_3\text{GaTe}_2/\text{MoS}_2/\text{Fe}_3\text{GaTe}_2$  device. (a) MR curves measured at different temperatures from 70 K to 310 K with a fixed bias current of 10 nA. (b) The extracted MR ratios as a function of temperature. (c) Spin polarization as a function of temperature. The blue line is the fitting curve according to the Bloch law.

the  $\text{MoS}_2$  spacer, which can be further improved by replacing the spacer layer with wide-bandgap semiconductors or insulators. The temperature-dependence of  $P$  was fitted based on the Bloch law<sup>51</sup> using the equation  $P(T) = P(0)(1 - \alpha T^{3/2})$ , where  $P(0)$  refers to the spin polarization at 0 K, and  $\alpha$  is a material-dependent constant.<sup>52,53</sup> The  $\alpha$  of our spin valve was  $1.6 \times 10^{-4} \text{ K}^{-3/2}$ , which is larger than those of Co ( $1-6 \times 10^{-6} \text{ K}^{-3/2}$ ) and NiFe ( $3-5 \times 10^{-5} \text{ K}^{-3/2}$ ).<sup>54</sup> Generally,  $\alpha$  is larger for the surface compared with the bulk due to surface exchange softening.<sup>55,56</sup> The larger  $\alpha$  here may be the result of interface scattering.<sup>57</sup>

### 3. Conclusion

We report a room-temperature, FM 2D crystal-based all-2D vdW spin-valve heterojunction device with a typical spin-valve effect, showing strong spacer ( $\text{MoS}_2$ )-thickness-dependence in the vdW heterojunctions. The MR of the all-2D vdW spin valve device was 15.89% at 2.3 K and 11.97% at 10 K, which are 4–30 times the MR of the spin valves of  $\text{Fe}_3\text{GaTe}_2/\text{MoS}_2/\text{Fe}_3\text{GaTe}_2$  and conventional NiFe/ $\text{MoS}_2$ /NiFe. Importantly, the spin-valve effect could be robustly maintained at 300 K with low working currents down to 10 nA ( $0.13 \text{ A cm}^{-2}$ ). This work provides a general vdW platform for developing room temperature, 2D FM crystal-based 2D spin valve devices. Note that before submitting this work, we first published the results as preprint in arXiv.<sup>58</sup> Some discussions can be referred between these two

published versions. During the publication of this work, we also published our collaborated work using  $\text{WSe}_2$  as spacer<sup>50</sup> and our another work using  $\text{MoSe}_2$  spacer.<sup>59</sup>

## 4. Experimental section

### 4.1. Device fabrication

**4.1.1. Hall device.** A standard six-terminal Hall bar pattern was pre-fabricated on a Si substrate with a 300 nm oxidized layer using a direct laser-writing machine (MicroWriter ML3, DMO). The Cr/Au (5/25 nm) electrodes were deposited by e-beam evaporation (PD-500S, PDVACUUM), followed by a lift-off procedure. High-quality  $\text{Fe}_3\text{GaTe}_2$  single crystals were grown *via* a self-flux method, mechanically exfoliated and transferred onto the Hall bar using polydimethylsiloxane (PDMS) stamps.

**4.1.2.  $\text{Fe}_3\text{GaTe}_2/\text{MoS}_2/\text{Fe}_3\text{GaTe}_2$  heterojunction.** Four-terminal Cr/Au (5/25 nm) electrodes were pre-patterned on a  $\text{SiO}_2/\text{Si}$  substrate using the same process employed for Hall bar fabrication.  $\text{MoS}_2$  single crystals were purchased from Six Carbon Technology. First, the  $\text{Fe}_3\text{GaTe}_2$  flakes were mechanically exfoliated by Scotch tapes and transferred onto PDMS stamps. Then, the  $\text{Fe}_3\text{GaTe}_2$  flakes were selected and transferred onto the pre-fabricated electrodes on the  $\text{SiO}_2/\text{Si}$  substrate *via* a site-controllable dry transfer method with the help of an optical microscope. Afterwards, the  $\text{MoS}_2$  flakes were transferred onto the  $\text{Fe}_3\text{GaTe}_2$  flake, followed by another  $\text{Fe}_3\text{GaTe}_2$  flake with a

different thickness and shape from the first one to form a  $\text{Fe}_3\text{GaTe}_2/\text{MoS}_2/\text{Fe}_3\text{GaTe}_2$  heterojunction spin valve. To avoid oxidation, the whole exfoliation and transfer process was performed in a nitrogen-filled glove box ( $\text{H}_2\text{O}$ ,  $\text{O}_2 < 0.1$  ppm).

#### 4.2. Device tests

The thickness of the  $\text{Fe}_3\text{GaTe}_2$  and  $\text{MoS}_2$  flakes were identified by atomic force microscopy (AFM, XE7, Park; SPM9700, Shimadzu; Dimension EDGE, Bruker). The Raman spectra were obtained using a Raman spectrometer (LabRAM HR800, Horiba Jobin-Yvon) with an excitation wavelength of 532 nm. The magneto-transport and electrical transport properties were measured in a physical property measurement system (PPMS, DynaCool, Quantum Design). The magnetic field was applied parallel to the  $c$ -axis of  $\text{Fe}_3\text{GaTe}_2$ . At each magnetic field or temperature sampling point, the resistance was measured 25 times to obtain an average in the constant current mode.

## Author contributions

H. C. designed the project. W. J. and G. Z. prepared the materials and fabricated the devices. W. J., H. W. and L. Y. did the crystal characterization and physical property measurements. H. C., W. Z. and W. J. analyzed the results. H. C. and W. J. wrote the paper. All authors discussed the results and commented on the manuscript.

## Conflicts of interest

The authors declare no conflict of interest.

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